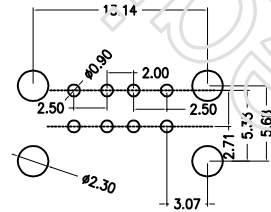
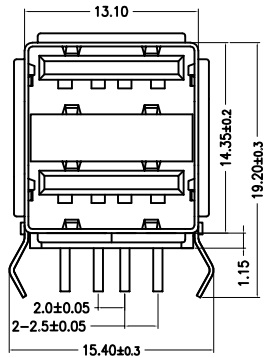
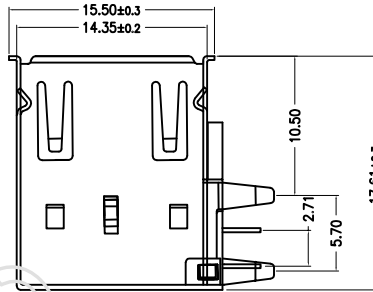
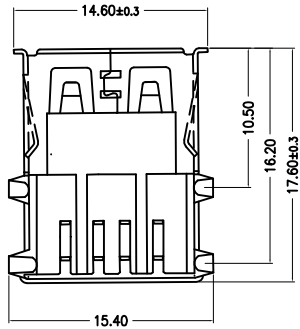


* 所有原料材质, 生产制程, 电镀必须符合ROHS要求



P.C.B PATTBRN LAY OUT

MATERIALS

- 1: housing:PBT+30%GlassFiber (UL94V-0)
- 2: Contact:copper alloy
- 3: shell:ferroalloy/copper alloy

SPECIFICATIONS

- 1: contact current rating: 1.5A max.Per pin
- 2: voltage rating:30v AC/DC.
- 3: contact Resistance:30m Ω max
- 4: Insulation Resistance:1000 M Ω min.AT DC 500V

XNTUSBAFSC-X-DIP

- 类别:
- A:外壳弯脚, 四面翻边
 - B:外壳弯脚, 四面直边



深圳市鑫南天科技有限公司

Shen zhen Shi Xin Nan Tian Industrial Co., Ltd

DIMENSIONS INIT: mm UNLESS OTHERWISE SPECIFIABLE		PRODUCT NAME : USB AF DIP 板上 双层 外壳/端子 全插	DRAWING: COCO	DATE: 2008/12/10
X. ±0.3	X° ±5°	PRODUCT NO. : XNTUSBAFSC-X-DIP	CHECK: JANY	DATE: 2008/12/10
.X ±0.2	.X° ±2°	DRAWING NO. : XNTUSBAF-002	APPROVED: JEFF	DATE: 2008/12/10
.XX ±0.15	.XX° ±1°	SCALE: 1:1	DWG ID: P D	REV.: B
.XXX ±0.05	.XXX° ±0.5°	1:1	REV.: B	PAGE: 1 of 1

REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE
1				
2				